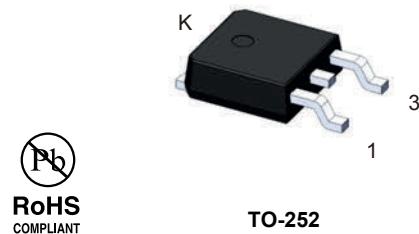


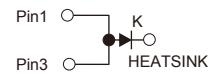
## Features

- Power pack
- Metal silicon junction, majority carrier conduction
- Guard ring for over-voltage protection
- Low power loss, high efficiency
- High current capability, low forward voltage drop
- High forward surge capability
- High frequency operation
- High temperature soldering guaranteed: 260°C/10 seconds at terminals
- Component in accordance to RoHS 2015/863/EU



## Mechanical Data

- Case: JEDEC TO-252
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked



Schematic Diagram

## Applications

For use in low voltage, high frequency inverters, DC/DC converters, free wheeling, and polarity protection applications

## Maximum Ratings (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	60	V
Maximum Forward Average Rectified Current (See Fig.1)	$I_{F(AV)}$	5.0	A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	$I_{FSM}$	150	A
Typical Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.5	°C/W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	°C

## Electrical Characteristics (Pin 1&3 is shorted, $T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Test Conditions		Typ.	Max.	Unit
Instantaneous Forward Voltage <sup>1</sup>	$V_F$	$I_F=5A$	$T_J=25^\circ C$	0.62	0.70	V
			$T_J=125^\circ C$	0.54	-	
Reverse Current <sup>2</sup>	$I_R$	$V_R=60V$	$T_J=25^\circ C$	-	100	$\mu A$
			$T_J=125^\circ C$	-	25	mA
Typical Junction Capacitance	$C_J$	$4V, 1MHz$		215	-	pF

Notes:

1. Pulse test: 300μS pulse width, 1% duty cycle
2. Pulse test: pulse width ≤40ms

## Ratings and Characteristics Curves

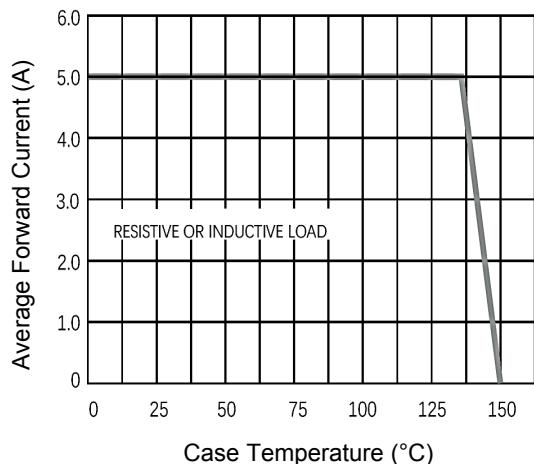


Figure 1. Forward Current Derating Curve

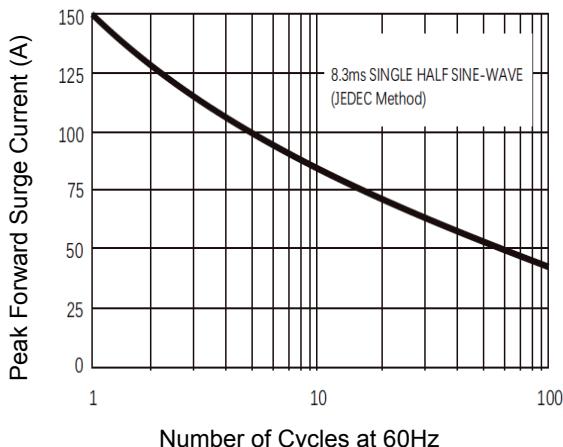


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

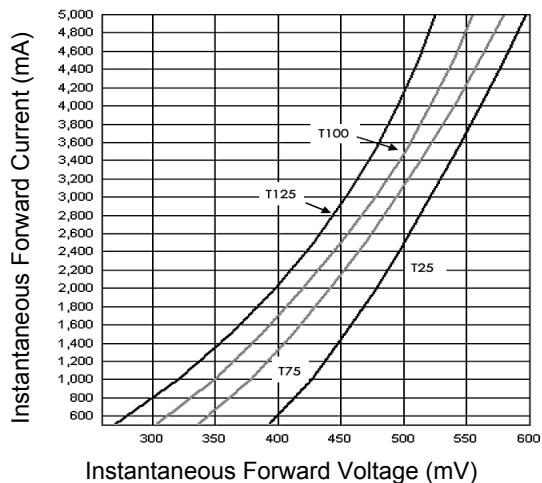


Figure 3. Typical Instantaneous Forward Characteristics

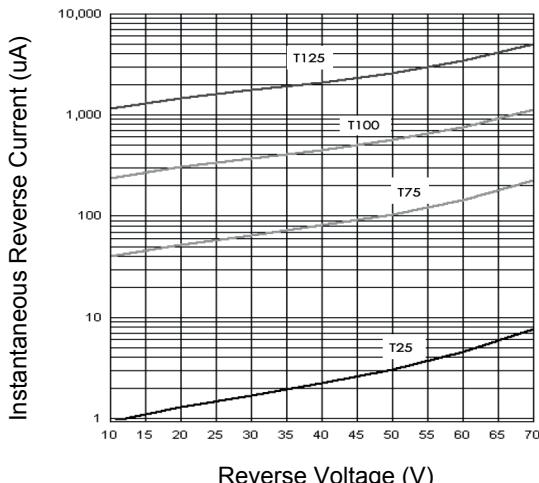


Figure 4. Typical Reverse Characteristics

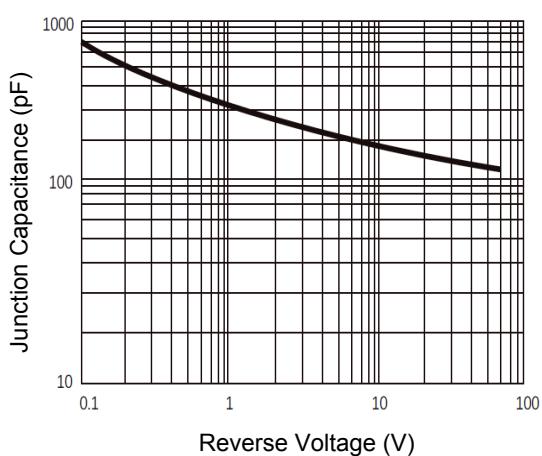
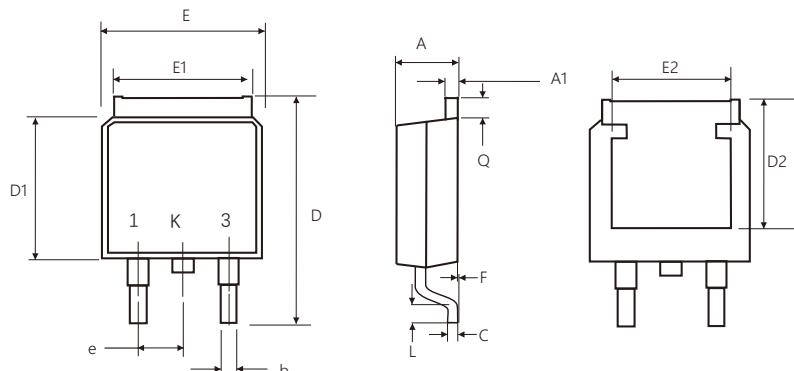


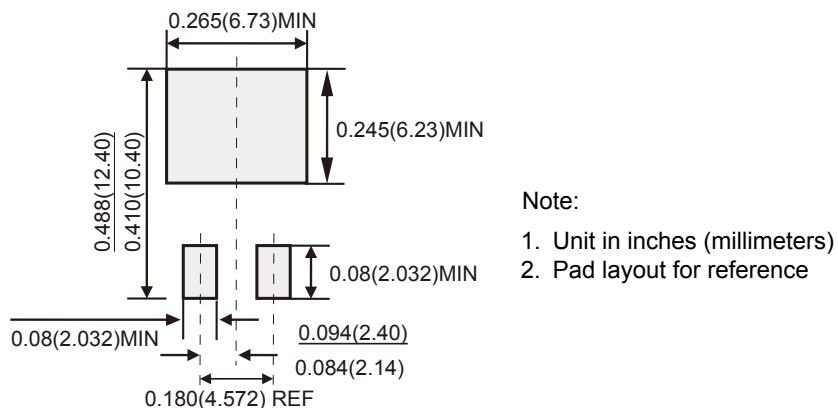
Figure 5. Typical Junction Capacitance

## Package Outline Dimensions (TO-252)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.15	2.65	0.085	0.104
A1	0.42	0.58	0.017	0.023
e	2.14	2.40	0.084	0.094
b	0.64	0.89	0.025	0.035
Q	0.88	1.27	0.035	0.050
C	0.42	0.58	0.017	0.023
D	9.00	10.41	0.354	0.410
D1	5.60	6.22	0.220	0.245
E	6.20	6.73	0.244	0.265
E1	5.21	5.46	0.205	0.215
L	1.00	-	0.039	-
F	0.01	0.11	0.000	0.004
D2	5.11	5.58	0.201	0.220
E2	4.31	5.33	0.170	0.210

## Recommended Pad Layout



## Order Information

Device	Package	Marking	Carrier	Quantity
GSR560M3	TO-252	SR560M3	Tape & Reel	2,500pcs / Reel

For more information, please contact us at: [inquiry@goodarksemi.com](mailto:inquiry@goodarksemi.com)